

isc N-Channel MOSFET Transistor

2SK1011

DESCRIPTION

- Drain Current $-I_D=10A@ T_C=25^{\circ}C$
- Drain Source Voltage-
: $V_{DSS}= 450V(\text{Min})$

APPLICATIONS

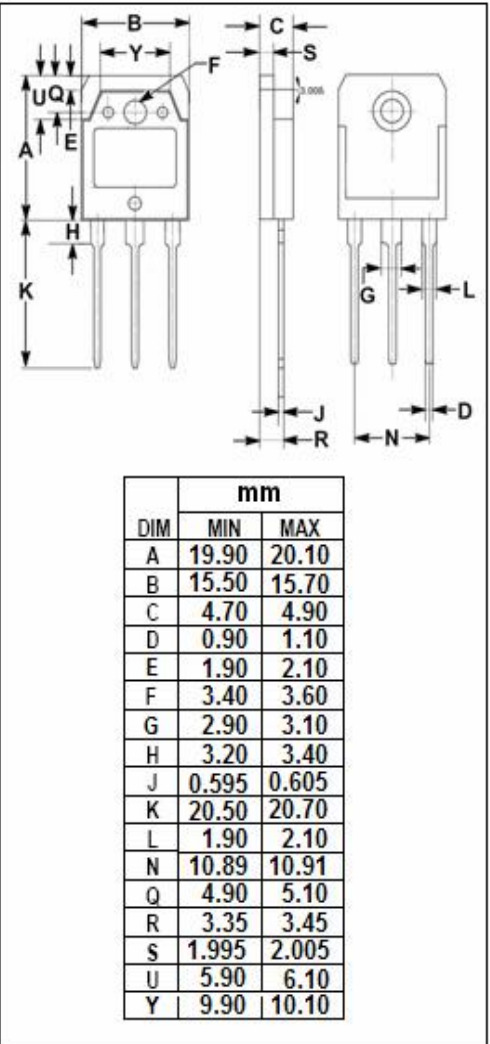
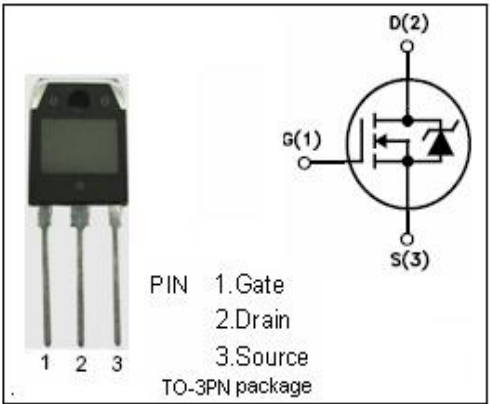
- high voltage, high speed power switching

ABSOLUTE MAXIMUM RATINGS($T_a=25^{\circ}C$)

SYMBOL	ARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage ($V_{GS}=0$)	450	V
V_{GS}	Gate-Source Voltage	± 30	V
I_D	Drain Current-continuous@ $TC=25^{\circ}C$	10	A
P_{tot}	Total Dissipation@ $TC=25^{\circ}C$	100	W
T_j	Max. Operating Junction Temperature	150	$^{\circ}C$
T_{stg}	Storage Temperature Range	-55~150	$^{\circ}C$

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th\ j-c}$	Thermal Resistance,Junction to Case	1.25	$^{\circ}C/W$
$R_{th\ j-a}$	Thermal Resistance,Junction to Ambient	35	$^{\circ}C/W$



isc N-Channel Mosfet Transistor**2SK1011****• ELECTRICAL CHARACTERISTICS (T_C=25°C)**

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0; I _D = 1mA	450			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} ; I _D =1mA	2.5	3.5	5.0	V
R _{DS(on)}	Drain-Source On-stage Resistance	V _{GS} =10V; I _D = 5A		0.5	0.65	Ω
I _{GSS}	Gate Source Leakage Current	V _{GS} = ±30V; V _{DS} = 0			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 450V; V _{GS} = 0			500	uA
V _{SD}	Forward On-Voltage	I _S =10A; V _{GS} =0		1.1	1.5	V
tr	Rise time	V _{GS} =10V; I _D =10A; R _L =25 Ω		80	120	ns
ton	Turn-on time			110	165	ns
tf	Fall time			80	120	ns
toff	Turn-off time			240	360	ns